

ABSTRACT

A curable composition containing components (A) to (E) as follows, and containing 12 to 85% by mass of the component (A), 12 to 85% by mass of the component (B), and 0.5 to 20%
5 by mass of the component (C), relative to 100% by mass in total of the component (A), the component (B) and the component (C): (A) an organic solvent having an initial boiling point of 85°C or higher and lower than 145°C; (B) an organic solvent having an initial boiling point of 145°C or
10 higher and lower than 190°C; (C) an organic solvent having an initial boiling point of 190°C or higher and lower than 250°C; (D) a polysilazane compound; and (E) a catalyst. According to the present invention, there is provided a curable composition excellent in drying properties, recovery
15 workability after an elapse of a certain period of time, and water repellency of a coating film.

No Figure